

Product Change Notification / GBNG-05DBFM122

Date:

21-Jun-2024

Product Category:

Driver / Interface ICs, EL Backlight Driver ICs, Switching Regulators

PCN Type:

Manufacturing Change

Notification Subject:

CCB 6085 Final Notice: Qualification of UNIG as an additional final test site for LM2574, LM2575, MIC2145, MIC2202, MIC2203, MIC2204, MIC2981, MIC4574, MIC4826, MIC4827, MIC4830, MIC4832, MIC4833, MIC5800, MIC5801, MIC5891, MIC58P01 and MIC59P50 device families available in Tube and Tape & Reel packing media.

Affected CPNs:

GBNG-05DBFM122_Affected_CPN_06212024.pdf GBNG-05DBFM122_Affected_CPN_06212024.csv

Notification Text:

PCN Status: Final Notification

PCN Type:Manufacturing Change

Microchip Parts Affected:Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

Description of Change:Qualification of UNIG as an additional final test site for LM2574, LM2575, MIC2145, MIC2202, MIC2203, MIC2204, MIC2981, MIC4574, MIC4826, MIC4827, MIC4830, MIC4832, MIC4833, MIC5800, MIC5801, MIC5891, MIC58P01 and MIC59P50 device families available in Tube and Tape & Reel packing media.

Pre and Post Change Summary:

		Pre Change	Post Change							
		Unisem (M) Berhad Perak,	Unisem (M) Berhad Perak,	Unisem (M) Berhad Gopeng						
Final Test Site		Malaysia	Malaysia							
		(UNIS)	(UNIS)	UNIG						
Base Quantity Multiple (BQM)	No change									
Pin 1 Orientation		No change								
Carrier Tape	Tape and	No dimensional changes.								
Cover Tape	Reel	No dimensional changes.								
Dimension		No dimensional changes.								
Color		No change								
Base Quantity Multiple (BQM)			No change							
Pin 1 Orientation	- 1	No change								
Dimension	Tube	No dimensional changes.								
Color		No change								
Packing Method			No change							

Impacts to Data Sheet:None

Change ImpactNone

Reason for Change:To improve on-time delivery performance by qualifying UNIG as an additional final test site.

Change Implementation Status: In Progress

Estimated First Ship Date: July 19, 2024 (date code: 2429)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Time Table Summary:

	May 2023				>	June 2024			July 2024							
Workweek	1	1	2	2	2		22	23	24	25	26	27	28	29	30	31

		_	_	_	_	_	_	_				
	8	9	0	1	2							
Initial PCN Issue Date		х										
Qual Report Availability									х			
Final PCN Issue Date									Х			
Estimated Implementation Date											х	

Method to Identify Change: Traceability code

Qualification Report:Please open the attachments included with this PCN labeled as PCN_#_Qual_Report.

Revision History: May 10, 2023: Issued initial notification.

June 21, 2024: Issued final notification. Attached the Qualification Report. Revised the Notification Subject to specify all affected device families. Provided estimated first ship date to be on July 19, 2024.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachments:

PCN_GBNG-05DBFM122_Qual_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. GBNG-05DBFM122 - CCB 6085 Final Notice: Qualification of UNIG as an additional final test site for LM2574, LM2575, MIC2145, MIC2202, MIC2203, MIC2204, MIC2981, MIC4574, MIC4826, MIC4827, MIC4830, MIC4832, MIC4833, MIC5800, MIC5801, MIC5891, MIC58P01 and MIC59P50 device families available in Tube and Tape & Reel packing media.

Affected Catalog Part Numbers (CPN)

LM2574-12YN LM2574-3.3YN LM2574-5.0YN LM2574YN LM2575-12YN LM2575-12YWM LM2575-12YWM-TR LM2575-3.3YN LM2575-3.3YWM LM2575-3.3YWM-TR LM2575-5.0YN LM2575-5.0YWM LM2575-5.0YWM-TR LM2575YN LM2575YWM LM2575YWM-TR MIC2145YML MIC2145YML-TR MIC2145YMM MIC2145YMM-TR MIC2202YML MIC2202YML-TR MIC2203YML-TR MIC2204YML MIC2204YML-TR MIC2204YMM MIC2204YMM-TR MIC2981/82YN MIC2981/82YWM MIC2981/82YWM-TR MIC4574-3.3YN MIC4574-5.0YN MIC4574YN MIC4826YMM MIC4826YMM-TR MIC4827YMM MIC4827YMM-TR MIC4830YML-TR MIC4832YML-TR MIC4833YML-TR MIC5800YM MIC5800YM-TR MIC5800YN MIC5801BWM MIC5801BWM-TR MIC5801YV

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QUALIFICATION REPORT SUMMARY

PCN #: GBNG-05DBFM122

Date: June 10, 2024

Qualification of UNIG as an additional final test site for LM2574, LM2575, MIC2145, MIC2202, MIC2203, MIC2204, MIC2981, MIC4574, MIC4826, MIC4827, MIC4830, MIC4832, MIC4833, MIC5800, MIC5801, MIC5891, MIC58P01 and MIC59P50 device families available in Tube and Tape & Reel packing media. Purpose: Qualification of UNIG as an additional final test site for LM2574, LM2575, MIC2145, MIC2202, MIC2203, MIC2204, MIC2981, MIC4574, MIC4826, MIC4827, MIC4830, MIC4832, MIC4833, MIC5800, MIC5801, MIC5891, MIC58P01 and MIC59P50 device families available in Tube and Tape & Reel packing media.

CCB No. 6085

Test Name	Test Conditions	Sample Size	Qty of Lots	Fail/Accept Criteria	Result
Bin and Yield Comparison	Test the same units at existing and destination locations and compare BIN and Yield data.	3000	1	≤0.1%	Passed
Parametric Correlation	Characterize the same units at existing and destination locations and compare data.	33	1	≤10%	Passed
Correlation Lot report	 Yield at each step and reject analysis between systems. 33 units are tested as lot correlation. Accept on yield match within 0.1% 	33	1	≤0.1%	Passed